

NOTES (UNLESS OTHERWISE SPECIFIED):

GENERAL

- 1) PCB IS 7-LAYER, .062" THICK,
- 2) CONSTRUCTION IS SOLDER-MASK-OVER-BARE-COPPER (SMOBC).
- 3) ACCEPTABILITY SHALL BE BASED ON PC-A-600, CLASS 2.
 4) THE FOLLOWING GERBER RS274X PHOTO TOOL FLES SHALL BE USED TO DEFINE ALL CIRCUIT FEATURES:

*.GTL - TOP LAYER GERBER DATA

*.GP1 - INTERNAL PLANE LAYER 1 GERBER DATA *.GP2 - INTERNAL PLANE LAYER 2 GERBER DATA

*.GP3 - INTERNAL PLANE LAYER 3 GERBER DATA

*.GP4- INTERNAL PLANE LAYER 4 GERBER DATA

*.GP5- INTERNAL PLANE LAYER 5 GERBER DATA

*.GBL - BOTTOM LAYER GERBER DATA

*.GTO - TOP OVERLAY GERBER DATA

*GRO - BOTTOM OVERLAY GERBER DATA

*.GTP - TOP-SIDE SOLDER PASTE MASK

*.GBP - BOTTOM-SIDE SOLDER PASTE MASK

*.GTS - TOP SOLDER MASK GERBER DATA

*.GBS - BOTTOM SOLDER MASK GERBER DATA

5) THE PHOTO TOOL SHALL NOT BE COMPENSATED WITHOUT PRIOR ENGINEERING APPROVAL PCB DESIGNER: RICH LOBDILL PH (805) 880-1621 FAX (805) 961-1792.

FABRICATION TOLERANCES

- 6) END PRODUCT CONDUCTOR WIDTHS AND PAD DIAMETERS SHALL NOT VARY MORE THAN 0.002" FROM THE 1:1 DIMENSIONS OF THE MASTER ARTWORK.
- 7) THE CONDUCTIVE PATTERN SHALL BE POSITIONED SO THAT THE LOCATION OF ANY PAD OR LAND SHALL BE WITHN 0.005" DAMETER TO THE TRUE POSITION OF THE HOLE IT CRCUMSCRIBES. 8.1) DRLL TOLERANCES +/- 0.003" 8.2) ALL DRLL HOLE SZES AND TOLERANCES APPLY AFTER PLATING.
- 9) THE MINIMUM ANNULAR RING SHALL BE 0.005".
- 10) BOW AND TWIST SHALL NOT EXCEED 0.010" PER INCH.

 11) FOR PCB ROUTING DIMENSIONS: .XXX = +/-.005" .XX = +/-.020"

MATERIAL

- 12) BASE MATERIAL IS FR4 EPOXY FIBERGLASS
- 13) SEE STACK-UP LEGEND FOR COPPER CLADDING CALL OUTS

- 14) ALL HOLES AND CONDUCTIVE SURFACES SHALL BE PLATED WITH A MINIMUM OF 0.001" COPPER.
 15) AFTER SOLDERMASK, ALL EXPOSED HOLES AND CONDUCTIVE SURFACES SHALL BE COATED
- WITH A GOLD IMMERSION PLATING TO PRESERVE SOLDERABILITY.

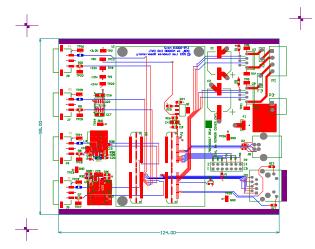
- 16) THE SOLDERMASK SHALL BE BLACK LIQUID PHOTO-MAGEABLE PER IPC-SM-840, TYPE-B, CLASS 2.
- 17) THE SOLDERMASK REGISTRATION ALLOWANCE IS 0.003". THERE SHALL BE NO SOLDERMASK ON ANY SOLDER PAD OR LAND.

- 18) THE LEGEND SHALL BE SCREEN-PRINTED USING PERMANENT YELLOW EPOXY NK.
 19) THE SCREEN PRINTING REGISTRATION ALLOWANCE IS 0.007". THERE SHALL BE NO INK ON ANY SOLDER PAD OR LAND.
- 20) THE VENDOR CODE AND UL FLAMMABILITY RATING MAY BE ETCHED IN THE FOIL OR MARKED IN

ELECTRICAL TESTING

ALL BOARDS SHALL BE ELECTRICALLY TESTED TO THE SUPPLED PC-D-356A NET LIST FOR CONTINUITY, OPENS AND SHORTS.

Layer Stack Up Det	ail for: 175-00013 rev2.PcbDoc
Layer Name	Copper cladding
Top Layer (*GTL)	1/2 oz. (1 oz. Finished)
+24U (*.GP1)	1/2 oz
GND (*.GP2)	1/2 oz
+12V (*.GP3)	1/2 oz
+3.3V (*.GP4)	1/2 oz
-12V (*.GP5)	1/2 oz
Bottom Layer (*.GBL)	1/2 oz. (1 oz. Finished)



175-00013 rev 2, 1m Mirror Cover Controller

*.GTO - BIOPHOWERLASY RECERBED A DATA TA

PRIMARY PCB SPECIFICATIONS (REFER TO COMPLETE SPEC LISTING AT LEFT FOR FURTHER DETAILS) 7 NUMBER OF LAYERS -FINISHED THICKNESS .062"

FR4

GOLD IMMERSION PLATING TYPE SOLDER MASK COLOR -**BLACK**

BASE MATERIAL

Las Cumbres Observatory, Inc. Las Cumbres Observator 6740 Cortona Dr. Goleta, CA 93117 www.lcogt.net 11/2/2011 Rich Lobdil Rich Lobdill 175-00013, 1m Mirror Cover Controller - GPT " 2 1 0 € 20

NOTICE

THIS DRAWNG EMBODES A PROPRETARY DESON OWNED BY LAS CUMBRES OBSERVATORY, IT IS SUBMITED FOR A SPECIFIC PURPOSE UNDER A CONFIDENTIAL RELATIONSHIP, AND EXCEPT FOR PURPOSES DRIFESSLY GRAVITED WINTING, ALL ROSHS ARE RESERVED BY LAS CLAMBERS OBSERVATORY.